



## CS45N06 A4

### anGeneral Description:

CS45N06 A4 the silicon N-channel Enhanced VDMOSFETs, is obtained by the high density Trench technology which reduce the conduction loss, improve switching performance and enhance the avalanche energy. This device is suitable for use as a load switch and PWM applications. The package form is TO-252, which accords with the RoHS standard.

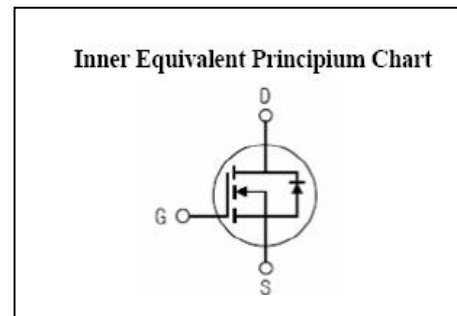
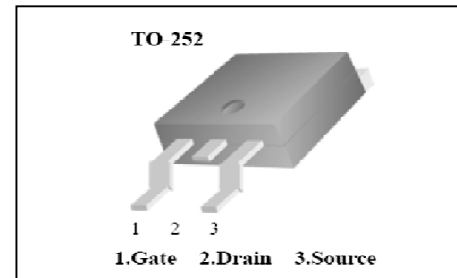
### Features:

- I **Fast Switching**
- I **Low ON Resistance**( $R_{ds(on)} \leq 16m\Omega$ )
- I **Low Gate Charge**
- I **Low Reverse transfer capacitances**
- I **100% Single Pulse avalanche energy Test**

### Applications:

- Power switch circuit of adaptor and charger;
- LED backlight driver;
- Synchronous rectification

$V_{DSS}$	60	V
$I_D$	45	A
$R_{DS(ON)Typ}$	12	$m\Omega$



### Absolute ( $T_j = 25^\circ C$ unless otherwise specified )

Symbol	Parameter	Rating	Units
$V_{DSS}$	Drain-to-Source Voltage	60	V
$I_D$	Continuous Drain Current $T_C = 25^\circ C$	45	A
	Continuous Drain Current $T_C = 100^\circ C$	30	A
$I_{DM}^{a1}$	Pulsed Drain Current $T_C = 25^\circ C$	180	A
$V_{GS}$	Gate-to-Source Voltage	$\pm 20$	V
$E_{AS}^{a2}$	Avalanche Energy	121	mJ
$P_D$	Power Dissipation $T_C = 25^\circ C$	54.3	W
	Derating Factor above $25^\circ C$	0.43	W/ $^\circ C$
$T_J, T_{stg}$	Operating Junction and Storage Temperature Range	150, -55 to 150	$^\circ C$

**Electrical Characteristics** ( $T_j = 25^\circ\text{C}$  unless otherwise specified):

<b>OFF Characteristics</b>						
Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
$V_{DSS}$	Drain to Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	60	--	--	V
$I_{DSS}$	Drain to Source Leakage Current	$V_{DS}=60V, V_{GS}=0V, T_j=25^\circ\text{C}$	--	--	1	$\mu A$
		$V_{DS}=48V, V_{GS}=0V, T_j=125^\circ\text{C}$	--	--	100	
$I_{GSS(F)}$	Gate to Source Forward Leakage	$V_{GS}=20V$	--	--	100	nA
$I_{GSS(R)}$	Gate to Source Reverse Leakage	$V_{GS}=-20V$	--	--	-100	nA

<b>ON Characteristics</b>						
Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
$R_{DS(ON)}$	Drain-to-Source On-Resistance	$V_{GS}=10V, I_D=20A$	--	12	16	$m\Omega$
		$V_{GS}=4.5V, I_D=15A$	--	15	20	$m\Omega$
$V_{GS(TH)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250\mu A$	1.0	1.5	2.0	V
Pulse width $t_p \leq 300\mu s, \delta \leq 2\%$						

<b>Dynamic Characteristics</b>						
Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
$R_g$	Gate resistance	$f=1\text{MHz}$	--	3.2	--	$\Omega$
$C_{iss}$	Input Capacitance	$V_{GS} = 0V, V_{DS} = 30V, f = 1.0\text{MHz}$	--	1876	--	pF
$C_{oss}$	Output Capacitance		--	135	--	
$C_{rss}$	Reverse Transfer Capacitance		--	102	--	

<b>Resistive Switching Characteristics</b>						
Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
$t_{d(ON)}$	Turn-on Delay Time	$V_{GS}=10V, R_G=3\Omega, V_{DD}=30V, I_D=20A$	--	13.1	--	ns
$t_r$	Rise Time		--	25.1	--	
$t_{d(OFF)}$	Turn-Off Delay Time		--	60.8	--	
$t_f$	Fall Time		--	9.2	--	
$Q_g$	Total Gate Charge	$I_D=20A, V_{DD}=30V, V_{GS}=10V$	--	43.45	--	nC
$Q_{gs}$	Gate to Source Charge		--	5.7	--	
$Q_{gd}$	Gate to Drain ("Miller") Charge		--	11.9	--	

Source-Drain Diode Characteristics						
Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
$I_S$	Continuous Source Current (Body Diode)	$T_C = 25^\circ\text{C}$	--	--	45	A
$I_{SM}$	Maximum Pulsed Current (Body Diode)		--	--	180	A
$V_{SD}$	Diode Forward Voltage	$I_S = 20\text{A}, V_{GS} = 0\text{V}$	--	--	1.2	V
$t_{rr}$	Reverse Recovery Time	$di/dt = 100\text{A}/\mu\text{s}$ $I_F = 20\text{A}$	--	29	--	ns
$Q_{rr}$	Reverse Recovery Charge		--	21	--	nC
Pulse width $t_p \leq 300\mu\text{s}$ , $\delta \leq 2\%$						

Symbol	Parameter	Max.	Units
$R_{\theta JC}$	Junction-to-Case	2.3	$^\circ\text{C}/\text{W}$
$R_{\theta JA}$	Junction-to-Ambient	62.5	$^\circ\text{C}/\text{W}$

<sup>a1</sup>: Repetitive rating; pulse width limited by maximum junction temperature

<sup>a2</sup>:  $L = 0.5\text{mH}, V_{DD} = 30\text{V}, I_{as} = 22\text{A}$  Start  $T_J = 25^\circ\text{C}$

<sup>a3</sup>: Recommend soldering temperature defined by IPC/JEDEC J-STD 020

## Characteristics Curve:

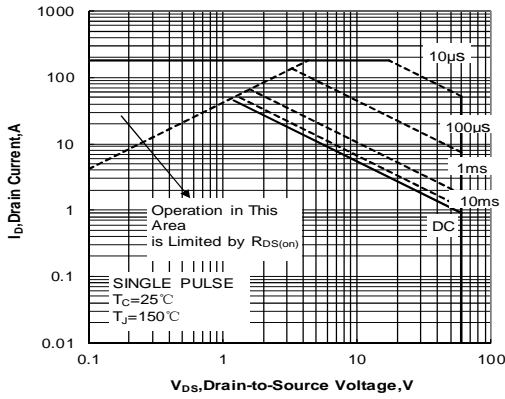


Figure 1 . Maximum Safe Operating Area

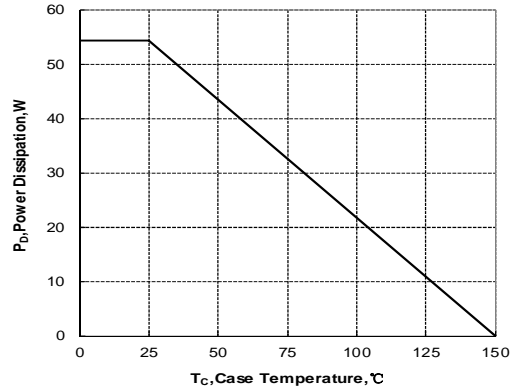


Figure 2. Maximum Power Dissipation vs Case Temperature

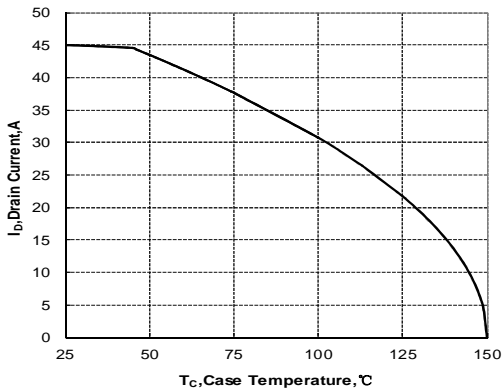


Figure 3. Maximum Continuous Drain Current vs Case Temperature

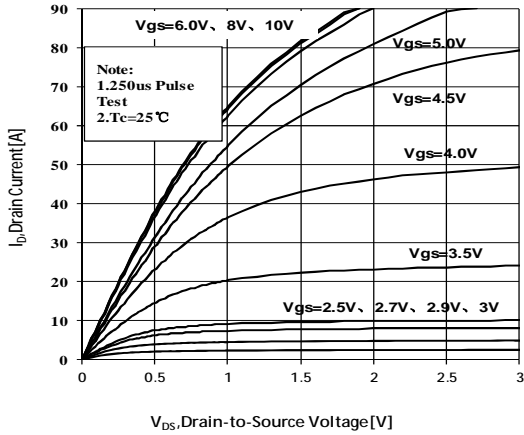


Figure 4. Typical output Characteristics

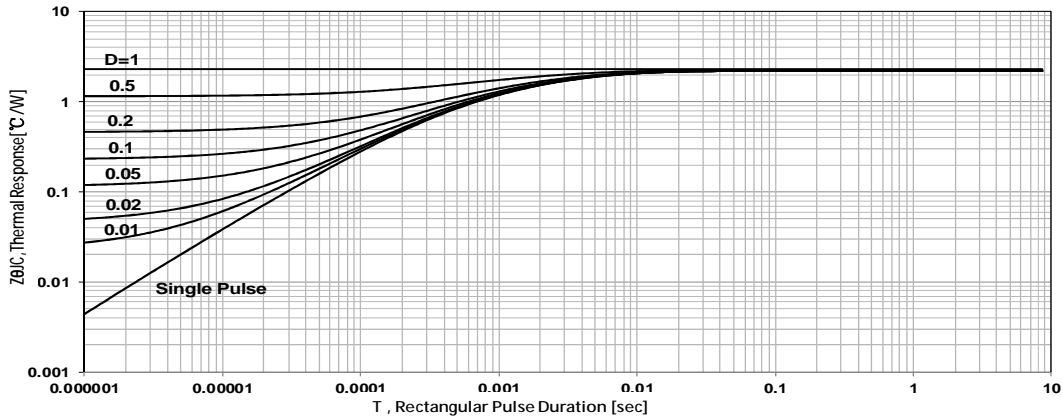


Figure 5 Maximum Effective Thermal Impedance , Junction to Case

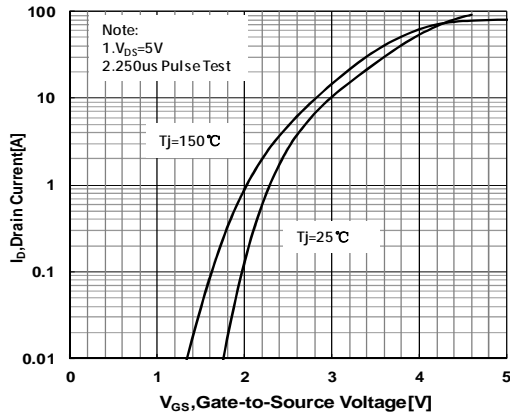


Figure 6 Typical Transfer Characteristics

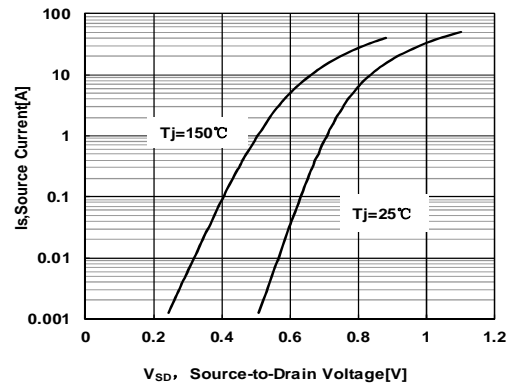


Figure 7 Typical Body Diode Transfer Characteristics

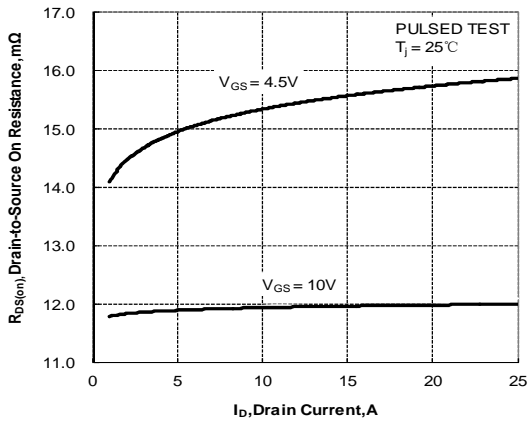


Figure 8. Drain-to-Source On Resistance vs Drain Current

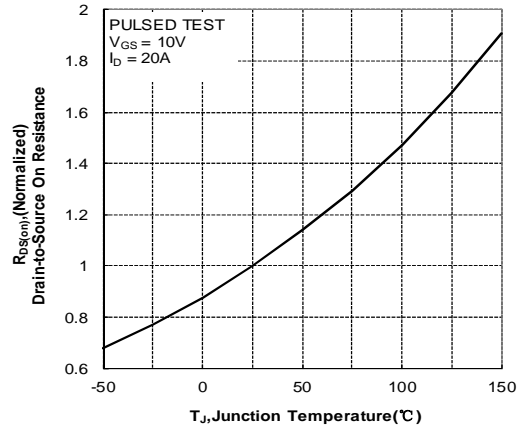


Figure 9. Normalized On Resistance vs Junction Temperature

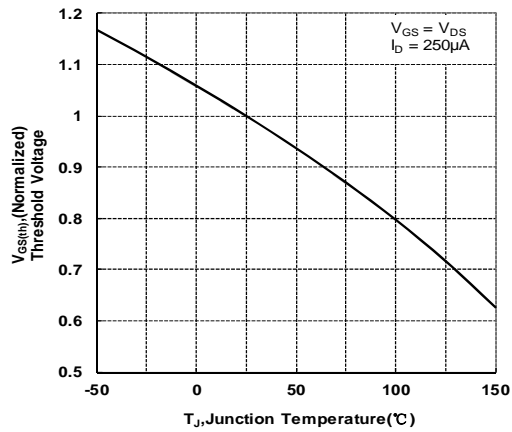


Figure 10. Normalized Threshold Voltage vs Junction Temperature

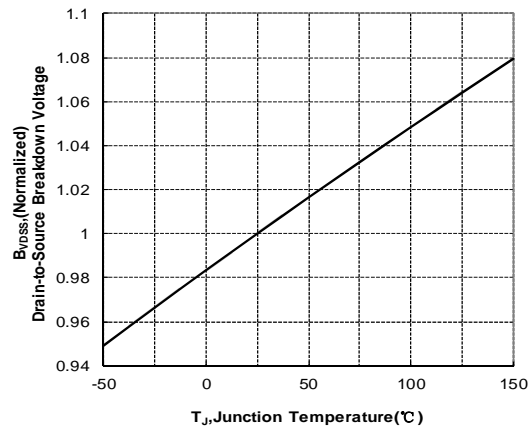


Figure 11. Normalized Breakdown Voltage vs Junction Temperature

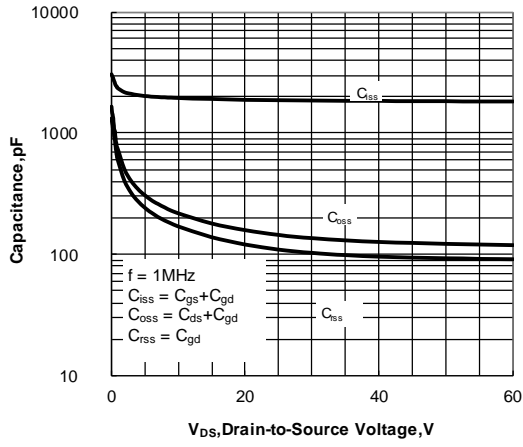


Figure 12. Capacitance Characteristics

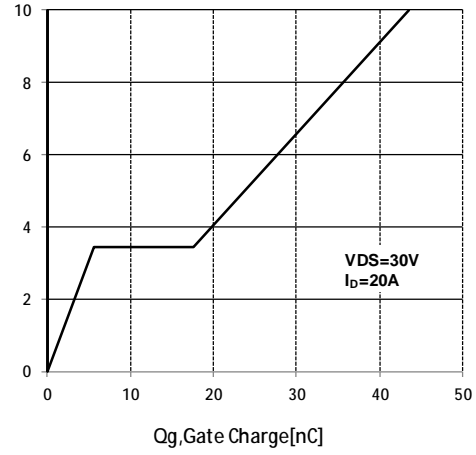


Figure 13 Typical Gate Charge vs Gate to Source Voltage

**Test Circuit and Waveform**



Figure 14. Gate Charge Test Circuit



Figure 15. Gate Charge Waveforms

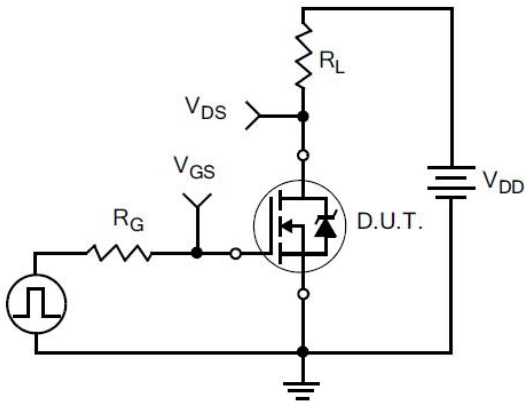


Figure 16. Resistive Switching Test Circuit



Figure 17. Resistive Switching Waveforms



Figure 18. Diode Reverse Recovery Test Circuit



Figure 19. Diode Reverse Recovery Waveform

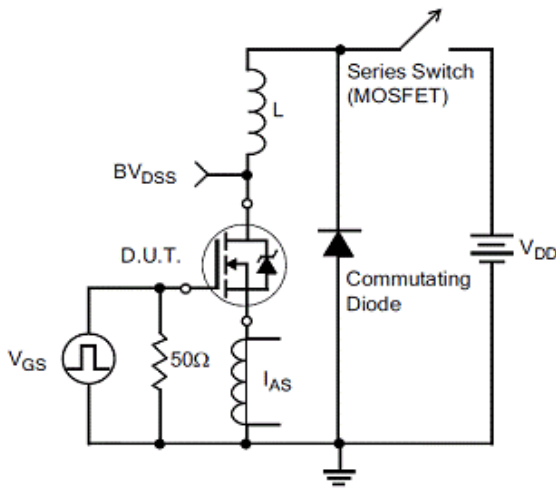
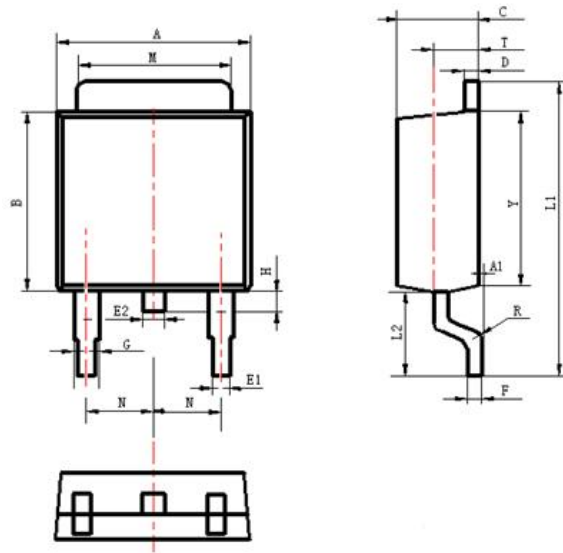


Figure20.Unclamped Inductive Switching Test Circuit



Figure21.Unclamped Inductive Switching Waveform



**Package Information:**


Items	Values(mm)	
	MIN	MAX
A	6.30	6.90
A1	0	0.16
B	5.70	6.30
C	2.10	2.50
D	0.30	0.70
E1	0.60	0.90
E2	0.70	1.00
F	0.30	0.60
G	0.70	1.20
L1	9.60	10.50
L2	2.70	3.10
H	0.40	1.00
M	5.10	5.50
N	2.09	2.49
R	0.3	
T	1.40	1.60
Y	5.10	6.30

TO-252 Package

**The name and content of poisonous and harmful material in products**

	Hazardous Substance									
	Pb	Hg	Cd	Cr(VI)	PBB	PBDE	DI BP	DEHP	DBP	BBP
Limit	≤0.1%	≤0.1%	≤ 0.01%	≤0.1%	≤0.1%	≤0.1%	≤0.1%	≤0.1%	≤0.1%	≤0.1%
Lead Frame	○	○	○	○	○	○	○	○	○	○
Molding	○	○	○	○	○	○	○	○	○	○
Chip	○	○	○	○	○	○	○	○	○	○
Wire Bonding	○	○	○	○	○	○	○	○	○	○
Solder	×	○	○	○	○	○	○	○	○	○
Note	○: Means the hazardous material is under the criterion of 2011/65/EU. ×: Means the hazardous material exceeds the criterion of 2011/65/EU. The plumbum element of solder exist in products presently, but within the allowed range of Eurogroup's RoHS.									

**Warnings**

1. Exceeding the maximum ratings of the device in performance may cause damage to the device, even the permanent failure, which may affect the dependability of the machine. It is suggested to be used under 80 percent of the maximum ratings of the device.
2. When installing the heatsink, please pay attention to the torsional moment and the smoothness of the heatsink.
3. VDMOSFETs is the device which is sensitive to the static electricity, it is necessary to protect the device from being damaged by the static electricity when using it.
4. This publication is made by Huajing Microelectronics and subject to regular change without notice.

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